



**PATENT**

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

**Notice of Allowance Mailed: August 22, 2006**

Application No.: 10/789,937  
Filing Date: February 27, 2004  
Applicant: Hisataka Toyoshima  
Group Art Unit: 1742  
Examiner: MAI, Ngoclan Thi  
Title: RAW OR GRANULATED POWDER FOR SINTERING,  
AND THEIR SINTERED COMPACTS  
Attorney Docket: 9319T-000696

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Director of the United States Patent and Trademark Office  
P.O. Box 1450  
Alexandria, VA 22313-1450

**MAKE OF RECORD LETTER**

Sir:

Please make the information set forth on the enclosed Form 1449 of record in this application. The listed documents were cited in a search report for a corresponding Chinese patent application. It is believed that the disclosures in these documents do not affect the allowability of the claims in this application.

Respectfully submitted,

Dated: November 20, 2006

By: \_\_\_\_\_

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FORM HDP-1449 (Based on Form PTO-1449)

**PATENT AND TRADEMARK OFFICE  
INFORMATION DISCLOSURE CITATION**

(Use several sheets if necessary)

Sheet 1 of 1

ATTORNEY DOCKET NO.

SERIAL NO.

9319T-000696

10/789,937

APPLICANT

Hisataka Toyoshima

FILING DATE

GROUP

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**U.S. PATENT DOCUMENTS**

Ref. Desig.	Examiner's Initials	Document Number	Date	Name	Class/ Subclass	(If appropriate) Filing Date
1.						

**FOREIGN PATENT DOCUMENTS**

Ref. Desig.	Examiner's Initials	Document Number	Date	Country	Class/ Subclass	Translation * Yes No
1.						

**OTHER DOCUMENTS (including Author, Title, Date, Pertinent Pages, etc.)**

Ref. Desig.	Examiner's Initials	
1.		Zhan et al., "Powder injection molding process & application", October 2003, pp 55-57, China and its English translation of the relevant part.
2.		Communication from Chinese Patent Office re: related application.

\*One or more of the English translation documents submitted herewith may be Abstracts only or partial machine created translations from the Japanese Patent Office. As such, the submitter does not necessarily vouch for their accuracy. Additional information may be obtained from the Japanese Patent Office web site at [www.jpo.go.jp](http://www.jpo.go.jp)

Examiner:

Date Considered:

EXAMINER: Please initial if citation considered, whether or not citation is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.